TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74VHCT139AF,TC74VHCT139AFN,TC74VHCT139AFT

Dual 2-to-4 Line Decoder

The TC74VHCT139A is an advanced high speed CMOS 2 to 4 LINE DECODER/DEMULTIPLEXER fabricated with silicon gate C²MOS technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

The active low enable input can be used for gating or it can be used as a data input for demultiplexing applications.

When the enable input is held High, all four outputs are fixed at a high logic level independent of the other inputs.

The input voltage are compatible with TTL output voltage.

This device may be used as a level converter for interfacing $3.3\ V$ to $5\ V$ system.

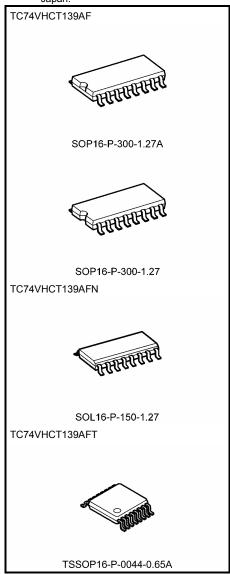
Input protection and output circuit ensure that 0 to 5.5 V can be applied to the input and output $^{\rm (Note)}$ pins without regard to the supply voltage. These structure prevents device destruction due to mismatched supply and input/output voltages such as battery back up, hot board insertion, etc.

Note: $V_{CC} = 0 V$

Features

- High speed: $t_{pd} = 5.0$ ns (typ.) at $V_{CC} = 5$ V
- Low power dissipation: $ICC = 4 \mu A \text{ (max)}$ at $Ta = 25^{\circ}C$
- Compatible with TTL outputs: VIL = 0.8 V (max)VIH = 2.0 V (min)
- Power down protection is provided on all inputs and outputs.
- Balanced propagation delays: tpLH ~ tpHL
- Low noise: VOLP = 0.8 V (max)
- Pin and function compatible with the 74 series (74AC/HC/F/ALS/LS etc.) 139 type.

Note: xxxFN (JEDEC SOP) is not available in Japan.



Weight

 SOP16-P-300-1.27A
 : 0.18 g (typ.)

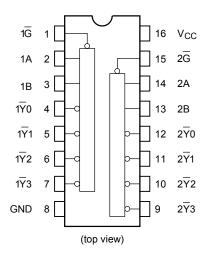
 SOP16-P-300-1.27
 : 0.18 g (typ.)

 SOL16-P-150-1.27
 : 0.13 g (typ.)

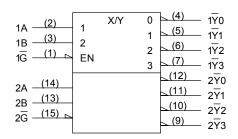
 TSSOP16-P-0044-0.65A
 : 0.06 g (typ.)

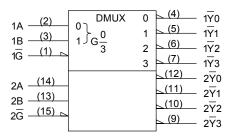


Pin Assignment



IEC Logic Symbol



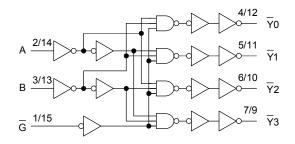


Truth Table

Inp		Out						
Enable	Select		- Y0	<u>-</u> Y1	_ Y2	_ Y3	Selected Output	
G	В	Α	10	T I	12	13	1	
Н	Х	Х	Н	Н	Н	Н	None	
L	L	L	L	Н	Н	Н	- Y0	
L	L	Н	Н	L	Н	Н	Y 1	
L	Н	L	Н	Н	L	Н	₹2	
L	Н	Н	Н	Н	Н	L	Y 3	

X: Don't care

System Diagram





Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V _{CC}	−0.5 to 7.0	V
DC input voltage	V _{IN}	-0.5 to 7.0	V
DC output voltage	V _{OUT}	-0.5 to 7.0 (Note 2)	٧
DC output voltage	VOU1	-0.5 to V _{CC} + 0.5 (Note 3)	
Input diode current	I _{IK}	-20	mA
Output diode current	lok	±20 (Note 4)	mA
DC output current	l _{OUT}	±25	mA
DC V _{CC} /ground current	I _{CC}	±50	mA
Power dissipation	P_{D}	180	mW
Storage temperature	T _{stg}	−65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Note 2: $V_{CC} = 0 V$

Note 3: High or low state. I_{OUT} absolute maximum rating must be observed.

Note 4: $V_{OUT} < GND$, $V_{OUT} > V_{CC}$

Recommended Operating Conditions (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage	V _{CC}	4.5 to 5.5	V
Input voltage	V _{IN}	0 to 5.5	V
Output voltage	V _{OUT}	0 to 5.5 (Note 2)	V
Culput Voltage	VOU1	0 to V _{CC} (Note 3)	V
Operating temperature	T _{opr}	−40 to 85	°C
Input rise and fall time	dt/dV	0 to 20	ns/V

Note 1: The recommended operating conditions are required to ensure the normal operation of the device.

Unused inputs must be tied to either VCC or GND.

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Note 2: $V_{CC} = 0 V$

Note 3: High or low state



Electrical Characteristics

DC Characteristics

Characteristics	Symbol		Test Condition			Ta = 25°C			Ta = -40 to 85°C	
Orial actoristics	Gymbol			V _{CC} (V)	Min	Тур.	Max	Min	Max	Unit
High-level input voltage	V _{IH}	-			2.0	_	_	2.0	_	V
Low-level input voltage	V _{IL}	-			_	_	0.8	_	0.8	V
High-level output	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -50 μA	4.5	4.40	4.50	_	4.40	_	٧
voltage			I _{OH} = -8 mA	4.5	3.94	_	_	3.80	_	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 50 μA	4.5	_	0.0	0.1	_	0.1	
			I _{OL} = 8 mA	4.5	_	_	0.36	_	0.44	V
Input leakage current	I _{IN}	V _{IN} = 5.5 V or GND		0 to 5.5	_	_	±1.0	_	±1.0	μA
Quiescent supply current	I _{CC}	V _{IN} = V _{CC} or GND		5.5	_	_	4.0	_	40.0	μA
	Ісст	Per input: V _{IN} = 3.4 V Other input: V _{CC} or GND		5.5	_	_	1.35	_	1.50	mA
Output leakage current	I _{OPD}	V _{OUT} = 5.5 V		0	_	_	0.5	_	5.0	μΑ

AC Characteristics (input: $t_r = t_f = 3 \text{ ns}$)

Characteristics	Symbol	Test Condition			Ta = 25°C			Ta = −40 to 85°C		Unit
			V _{CC} (V)	C _L (pF)	Min	Тур.	Max	Min	Max	
Propagation delay	t _{pLH}			15		5.0	7.2	1.0	8.5	ns
time $(A, B-\overline{Y})$	t _{pHL}	_	5.0 ± 0.5	50	-	6.5	9.2	1.0	10.5	
Propagation delay	t _{pLH}	-	5.0 ± 0.5	15	_	5.0	7.2	1.0	8.5	ns
time $(\overline{G} - \overline{Y})$	t _{pHL}			50	_	6.5	9.2	1.0	10.5	
Input capacitance	C _{IN}		_		_	4	10	_	10	pF
Power dissipation capacitance	C _{PD}			(Note)	_	32		_	_	pF

Note: CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

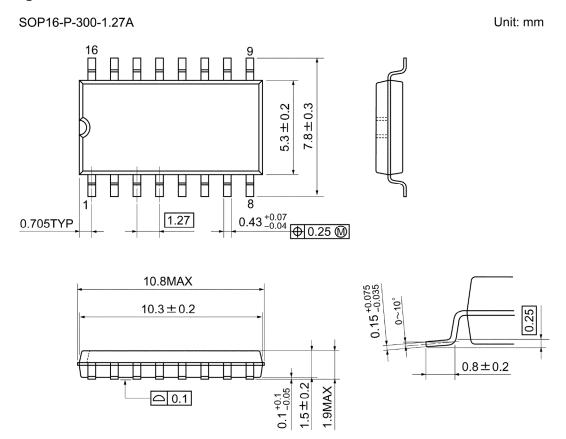
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Average operating current can be obtained by the equation:

 $I_{CC \text{ (opr)}} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/2 \text{ (per decoder)}$



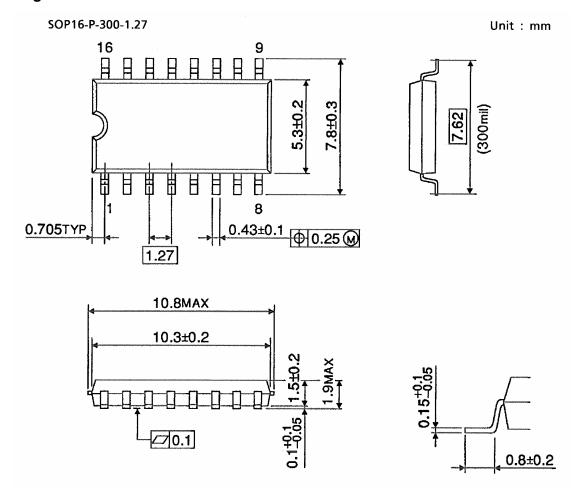
Package Dimensions



Weight: 0.18 g (typ.)



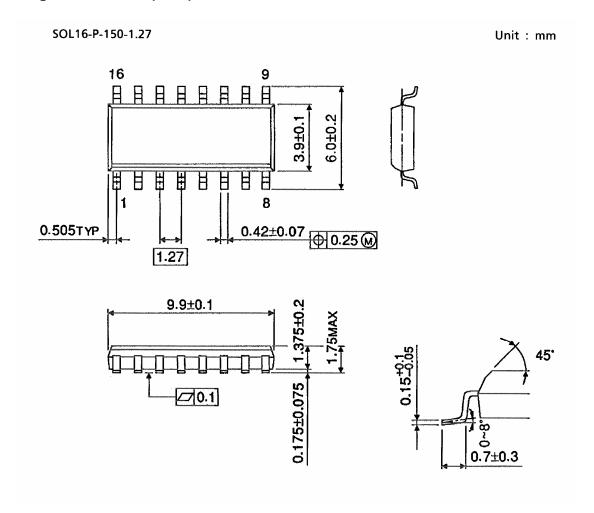
Package Dimensions



Weight: 0.18 g (typ.)



Package Dimensions (Note)



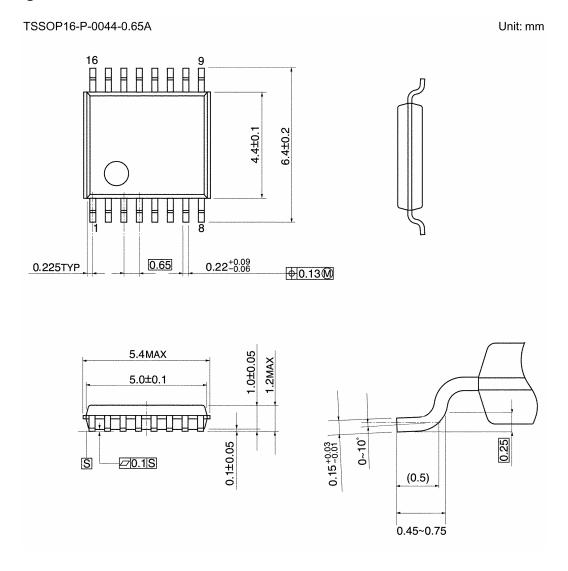
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Note: This package is not available in Japan.

Weight: 0.13 g (typ.)



Package Dimensions



Weight: 0.06 g (typ.)

Note: Lead (Pb)-Free Packages

SOP16-P-300-1.27A SOL16-P-150-1.27 TSSOP16-P-0044-0.65A

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